

Analysis for Overall???? How?

Total Responses = 81

Question 1: Multiple Choice	
AFTER taking this course, indicate the level of interest in MicroE.	% Responses
Very Interested	15%
Interested	63%
Neutral	21%
Not Interested	1%

Question 2: Multiple Answer	
I enjoyed learning the the following subjects	% Responses
Single / Multi chip packaging	53%
IC Assembly / PCB / PCB Assembly	53%
Thermal, Electrical	52%
Reliability Maths	44%
IC Failure Mech	64%
Package Fail Mech	56%

Question 3: Multiple Answer	
PSPICE Simulation Assignment	% Responses
Loved it	4%
Will be useful in my career	51%
Ok lah!	42%
Hated it	7%

Question 4: Multiple Answer	
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ANSYS Assignment	% Responses
Loved it!	16%
Will help me in my career	60%
Ok Lah!	22%
Hated it!	7%

Question 5: Multiple Choice	
Analytical Content - the course should be made	% Responses
More Analytical	40%
No Change	56%
Less Analytical	5%

Question 6: Multiple Answer	
CA Tests???? Do the tests help you with preparing for the exams / understanding the subject better?	% Responses
Very useful	40%
Useful	56%
Not useful	5%

Question 7: Short Answer/Essay	
Any other Recommendations, Comments?	
Click the View Responses button above to see a listing of all of the responses	

Analysis for Overall???? How? - individual response list

Total Responses = 81

Question: Short Answer/Essay

Any other Recommendations, Comments?

1. Case studies gives us a better idea of how theory is applied.
 2. Videos about packaging/manufacturing processes were extremely useful. I benefited from them a lot. Experimental data/results used in tutorial questions gave us a better feel of what are the actual "figures/sizes" in real world, especially in Micro-E where miniaturization is one of the driving forces. More materials/information highly related to the current industry will be helpful if they're included in lecture notes. Last but not least, this course has helped me overcome my fear in studying Micro-E related subject, which seemed to be a very difficult subject to me before.
 3. so far so good... thank you Dr. Subodh :)
 4. This module has already surpassed my expectations. Loved the videos! I guess a visit made optional to an actual factory making ICs will make the course complete with icing.
 5. good job
 6. the section on the Ic assembly and PCB assembly was abit too fast so din catch the essence. Thanks for the comic on the edventure and thanks for the sharing of your experience.
 7. This used to me my most fearful module, but after this course, confidence in Microelectronics has been build ever since. Thank You.
 8. sir, no sir, keep up the good work!
 9. The course seemed to be a bit packed. Probably it will be better if it can be split into more than 1 subject.
 10. for the later part of the lec(that's IC & pkg failure mech), it will be much better that if some short video chips are shown on how those mech works... After all, u have done a great job.. Thanx alot..
 11. The style of lecture which includes video and lab visits makes the course much more interesting.
 12. Interesting
 13. after attend the lect., i found that 468 is actually quite interesting, maybe because the way you delivery the information is clear and keep repeating so that we can receive more. right now, i can follow what you tought.
 14. videos shown are very interesting. hope to see more of them during the lectures.
 15. Video makes more understanding
 16. Having an agenda helps the student prepare for the lecture. Good Job!
 17. The lecture was delivered just at the right speed besides that some main points or "complecated" explanation could be delivered a little slower for every student to "digest".
 18. He is very knowledgeable in this field
 19. Makes sure the class understands what he is teaching by clarifying and repeating important concepts & difficult topics.
 20. Being able to relate what is taught to the industry to students.
 21. He is able to relate the basic principles very well.
 22. Excellent! Keep up the job sir!
 23. Approachable, patient, friendly. Please speak slowly.
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